

# **DATA SHEET**

ANTI-SULFURATED CHIP RESISTORS
AUTOMOTIVE GRADE

AF series 5%, 1%, 0.5%

sizes 0100/0201/0402/0603/0805/1206/1210/1218/2010/2512

RoHS compliant & Halogen free



**YAGEO** 



# SCOPE

This specification describes AF0100 to AF2512 chip resistors with anti-sulfuration capabilities.

### **APPLICATIONS**

- Industrial Equipment
- Power Application
- · Networking Application
- High-end Computer & Multimedia Electronics in high sulfur environment
- Automotive electronics

### **FEATURES**

- · AEC-Q200 qualified
- Superior resistance against sulfur containing atmosphere
- Halogen free product and production
- RoHS compliant
- Reduces environmentally hazardous waste
- High component and equipment reliability
- · Saving of PCB space
- Moisture sensitivity level: MSL I
- 50ppm available

### ORDERING INFORMATION - GLOBAL PART NUMBER

Part number is identified by the series name, size, tolerance, packaging type, temperature coefficient, taping reel and resistance value.

### **GLOBAL PART NUMBER**

### AF XXXX X X X XX XXX L (1) (2) (3) (4) (5) (6) (7)

### (I) SIZE

0100/0201/0402/0603/0805/1206/1210/1218/2010/2512

### (2) TOLERANCE

 $D = \pm 0.5\%$ 

 $F = \pm 1\%$ 

 $J = \pm 5\%$  (for jumper ordering, use code of J)

### (3) PACKAGING TYPE

R = Paper taping reel

K = Embossed plastic tape reel

### (4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

 $E = \pm 50 \text{ ppm/°C}$ 

### (5) TAPING REEL

07 = 7 inch dia, Reel

13 = 13 inch dia. Reel

7W = 7 inch dia. Reel & 2 x standard power

### (6) RESISTANCE VALUE

There are  $2\sim4$  digits indicated the resistance value. Letter R/K/M is decimal point. Detailed resistance rules are displayed in the table of "Resistance rule of global part number".

### (7) DEFAULT CODE

Letter L is system default code for ordering only (Note)

number Resistance coding re	ule Example
XRXX (1 to 9.76 Ω)	R =   Ω   R5 =  .5 Ω   9R76 = 9.76 Ω
XXRX (10 to 97.6 Ω)	$10R = 10 \Omega$ $97R6 = 97.6 \Omega$
XXXR (100 to 976 Ω)	100R = 100 Ω
XKXX (1 to 9.76 KΩ)	IK = 1,000 Ω 9K76 = 9760 Ω
XMXX (1 to 9.76 M $\Omega$ )	$IM = 1,000,000 \Omega$ $9M76 = 9,760,000 \Omega$

Resistance rule of global part

### **ORDERING EXAMPLE**

The ordering code for an AF0402 chip resistor, value  $100 \text{ K}\Omega$  with  $\pm 1\%$  tolerance, supplied in 7-inch tape reel with 10Kpcs quantity is: AF0402FR-07100KL.

#### NOTE

- All our R-Chip products are RoHS compliant and Halogen free. "LFP" of the internal 2D reel label states "Lead-Free Process"
- 2. On customized label, "LFP" or specific symbol can be printed





Chip Resistor Surface Mount | AF | SERIES | 0100 to 2512

**MARKING** 

### AF0100 / AF0201 / AF0402



No marking

U

### AF0603 / AF0805 / AF1206 / AF1210 / AF2010 / AF2512



E-24 series: 3 digits,  $\pm 5\%$ ,  $\geq 10\Omega$ 

First two digits for significant figure and 3rd digit for number of zeros

AF0603



Fig. 3 Value = 24  $\Omega$ 

E-24 series: 3 digits, ±1%

One short bar under marking letter



E-96 series: 3 digits, ±1%

First two digits for E-96 marking rule and 3rd letter for number of zeros

Fig. 4 Value = 12.4 K $\Omega$ 

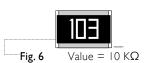
### AF0805 / AF1206 / AF1210 / AF2010 / AF2512



Both E-24 and E-96 series: 4 digits, ±1%

First three digits for significant figure and 4th digit for number of zeros

AF1218



E-24 series: 3 digits, ±5%

First two digits for significant figure and 3rd digit for number of zeros



Both E-24 and E-96 series: 4 digits,  $\pm 1\%$ 

First three digits for significant figure and 4th digit for number of zeros

### NOTE

For further marking information, please see special data sheet "Chip resistors marking". Marking of AF series is the same as RC series

AF

### CONSTRUCTION

The resistors are constructed on top of a high grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive glaze. The resistive glaze is covered by a glass.

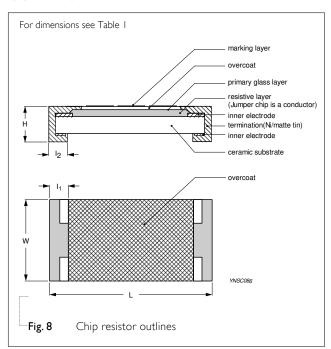
The composition of the glaze is adjusted to give the approximate required resistance value and laser trimming of this resistive glaze achieves the value within tolerance. The whole element is covered by a protective overcoat. Size 0603 and bigger is marked with the resistance value on top. Finally, the two external terminations (Ni / matte tin) are added. See fig.8

### **DIMENSIONS**

Table I	For outlines	see fig. 8
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TYPE	L (mm)	W (mm)	H (mm)	I⊨(mm)	I <sub>2</sub> (mm)
AF0100	0.40±0.02	0.20±0.02	0.14±0.02	0.10±0.03	0.10±0.03
AF0201	0.60±0.03	0.30±0.03	0.23±0.03	0.12±0.05	0.15±0.05
AF0402	1.00±0.05	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10
AF0603	1.60±0.10	0.80±0.10	0.45±0.10	0.25±0.15	0.25±0.15
AF0805	2,00±0.10	1.25±0.10	0.50±0.10	0.35±0.20	0.35±0.20
AF1206	3.10±0.10	1.60±0.10	0.55±0.10	0.45±0.20	0.50±0.20
AF1210	3.10±0.10	2.60±0.15	0.57±0.10	0.45±0.20	0.50±0.20
AF1218	3.10±0.10	4.60±0.10	0.57±0.10	0.45±0.20	0.50±0.20
AF2010	5.00±0.10	2.50±0.15	0.57±0.10	0.55±0.20	0.55±0.20
AF2512	6.35±0.10	3.20±0.15	0.57±0.10	0.60±0.20	0.60±0.20

### **OUTLINES**





# Chip Resistor Surface Mount | AF | SERIES | 0100 to 2512

## **ELECTRICAL CHARACTERISTICS**

### Table 2

					CHARACT	ERISTICS		
TYPE	POWER	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Resistance Range	Temperature Coefficient	Jumper Criteria
AF0100	1/32 W	–55 °C to 125°C	15V	30V	30V	5% (E24) $10\Omega \le R \le IM\Omega$ 1% (E24/E96) $10\Omega \le R \le IM\Omega$ Jumper $< 50m\Omega$	$10\Omega \le R < 100\Omega$ $\pm 300 \text{ ppm/°C}$ $100\Omega \le R \le \text{IM}\Omega$ $\pm 200 \text{ ppm/°C}$	Rated Current 0.5A Max. Current I.0A
AF0201	1/20 W		25V	50V	50V	5% (E24) $1\Omega \le R \le 10M\Omega$ 0.5%, $1%$ (E24/E96) $1\Omega \le R \le 10M\Omega$ Jumper $< 50m\Omega$	$ \Omega \le R \le  \Omega\Omega $ -100/+350 ppm/°C $ \Omega\Omega \le R \le  \Omega\Omega\Omega $ ±200 ppm/°C	Rated Current 0.5A Max. Current 1.0A
AF0402	1/16 W		50V	100V	100V	5% (E24) $1Ω ≤ R ≤ 22MΩ$ $0.5%$ , $1%$ (E24/E96) $1Ω ≤ R ≤ 10MΩ$ Jumper $< 50mΩ$	$\begin{split} &  \Omega \leq R \leq 10\Omega \\ & \pm 200 \text{ ppm/°C} \\ &  0\Omega < R \leq 10\text{M}\Omega \\ & \pm 100 \text{ ppm/°C} \\ &  0M\Omega < R \leq 22\text{M}\Omega \\ & \pm 200 \text{ ppm/°C} \\ &  00\Omega \leq R \leq 1\text{M}\Omega \\ & \pm 50 \text{ ppm/°C} \end{split}$	Rated Current I A Max. Current 2A
	1/8W	-	75V	100V	100V	5% (E24) $1\Omega \le R \le 10M\Omega$ 0.5%, $1%$ , (E24/E96) $1\Omega \le R \le 10M\Omega$	$1\Omega \le R < 10\Omega$ $\pm 200 \text{ ppm/°C}$ $10\Omega \le R \le 10M\Omega$ $\pm 100 \text{ ppm/°C}$	
AF0603	1/10 W	-55 °C to 155 °C -55 °C to -	75V	150V	150V	5% (E24) $1Ω ≤ R ≤ 22MΩ$ $0.5%$ , $1%$ (E24/E96) $1Ω ≤ R ≤ 10MΩ$ Jumper $< 50mΩ$	$I\Omega \le R < I\Omega\Omega$ $\pm 200 \text{ ppm/}^{\circ}\text{C}$ $I0\Omega \le R \le I0M\Omega$ $\pm 100 \text{ ppm/}^{\circ}\text{C}$ $I0M\Omega < R \le 22M\Omega$ $\pm 200 \text{ ppm/}^{\circ}\text{C}$ $I0M\Omega \le R \le I0M\Omega$ $\pm 50 \text{ ppm/}^{\circ}\text{C}$	Rated Current I A Max. Current 2A
	1/5 W		75V	150V	150V	5% (E24) $1Ω ≤ R ≤ 10MΩ$ $0.5%$ , $1%$ , (E24/E96) $1Ω ≤ R ≤ 10MΩ$	$1\Omega \le R < 10\Omega$ $\pm 200 \text{ ppm/}^{\circ}\text{C}$ $10\Omega \le R \le 10\text{M}\Omega$ $\pm 100 \text{ ppm/}^{\circ}\text{C}$	
AF0805	1/8 W		150V	300V	300V	5% (E24) $1Ω ≤ R ≤ 22MΩ$ $0.5%$ , $1%$ (E24/E96) $1Ω ≤ R ≤ 10MΩ$ Jumper $< 50mΩ$	$\begin{split} &  \Omega \leq R < 10\Omega \\ & \pm 200 \text{ ppm/°C} \\ &  0\Omega \leq R \leq 10\text{M}\Omega \\ & \pm 100 \text{ ppm/°C} \\ &  0M\Omega < R \leq 22\text{M}\Omega \\ & \pm 200 \text{ ppm/°C} \\ &  00\Omega \leq R \leq 10\text{M}\Omega \\ & \pm 50 \text{ ppm/°C} \end{split}$	Rated Current 2A Max. Current 5A
	1/4 W	•	150V	300V	300V	5% (E24) 1Ω ≤ R ≤ 10MΩ 0.5%, 1%, (E24/E96) 1Ω ≤ R ≤ 10MΩ	$I\Omega \le R < I0\Omega$ $\pm 200 \text{ ppm/°C}$ $I0\Omega \le R \le I0M\Omega$ $\pm 100 \text{ ppm/°C}$	
AF1206	1/4 W	-	200V	400V	500V	5% (E24) $1Ω ≤ R ≤ 22MΩ$ $0.5%$ , $1%$ (E24/E96) $1Ω ≤ R ≤ 10MΩ$ Jumper $< 50mΩ$	$\begin{split} &  \Omega \leq R < 10\Omega \\ & \pm 200 \text{ ppm/}^{\circ}\text{C} \\ &  0\Omega \leq R \leq 10M\Omega \\ & \pm 100 \text{ ppm/}^{\circ}\text{C} \\ &  0M\Omega < R \leq 22M\Omega \\ & \pm 200 \text{ ppm/}^{\circ}\text{C} \\ &  100\Omega \leq R \leq 10M\Omega \\ & \pm 50 \text{ ppm/}^{\circ}\text{C} \end{split}$	Rated Current 2A Max, Current 10A
	1/2 W	-	200V	400V	500V	5% (E24) $1\Omega \le R \le 10M\Omega$ 0.5%, $1%$ , (E24/E96) $1\Omega \le R \le 10M\Omega$	$I\Omega \le R < I0\Omega$ $\pm 200 \text{ ppm/°C}$ $I0\Omega \le R \le I0M\Omega$ $\pm 100 \text{ ppm/°C}$	



## **ELECTRICAL CHARACTERISTICS**

## Table 2

					CHARACT	ERISTICS		
TYPE	POWER	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Resistance Range	Temperature Coefficient	Jumper Criteria
AF1210	1/2 W	200V	500V	500V	$5\%$ (E24) $1\Omega \le R \le 10M\Omega$ $0.5\%$ , $1\%$ (E24/E96) $1\Omega \le R \le 10M\Omega$ Jumper $< 50m\Omega$	$\begin{split} &  \Omega \leq R <  0\Omega \\ & \pm 200 \text{ ppm/}^{\circ}\text{C} \\ &  0\Omega \leq R \leq  0M\Omega \\ & \pm  00 \text{ ppm/}^{\circ}\text{C} \\ &  00\Omega \leq R \leq  M\Omega \\ & \pm 50 \text{ ppm/}^{\circ}\text{C} \end{split}$	Rated Current 2A Max. Current 10A	
	ΙW		200V	500V	500V	$5\% \text{ (E24)}$ $1\Omega \leq R \leq 10M\Omega$ $0.5\%, 1\% \text{ (E24/E96)}$ $1\Omega \leq R \leq 10M\Omega$	$I\Omega \le R < I0\Omega$ $\pm 200 \text{ ppm/}^{\circ}\text{C}$ $I0\Omega \le R \le I0M\Omega$ $\pm 100 \text{ ppm/}^{\circ}\text{C}$	
AF1218	ΙW		200V	500V	500V	5% (E24) $1\Omega \le R \le 1M\Omega$ 0.5%, $1%$ (E24/E96) $1\Omega \le R \le 1M\Omega$ Jumper $< 50m\Omega$	$\begin{split} &  \Omega \leq R <  0\Omega \\ & \pm 200 \text{ ppm/°C} \\ &  0\Omega \leq R \leq  \text{IM}\Omega \\ & \pm  00 \text{ ppm/°C} \\ &  00\Omega \leq R \leq 2.2\text{M}\Omega \\ & \pm 50 \text{ ppm/°C} \end{split}$	Rated Current 2A Max, Current 10A
1.5 W	1.5 W	–55 °C to 155 °C	200V	500V	500V	$\begin{array}{c} 5\% \text{ (E24)} \\ \text{I } \Omega \leq \text{R} \leq \text{I M} \Omega \\ \text{0.5\%, I\% (E24/E96)} \\ \text{I } \Omega \leq \text{R} \leq \text{I M} \Omega \end{array}$	$I\Omega \le R < I0\Omega$ $\pm 200 \text{ ppm/}^{\circ}\text{C}$ $I0\Omega \le R \le IM\Omega$ $\pm I00 \text{ ppm/}^{\circ}\text{C}$	
AF2010	3/4 W	-	200V	500V	500V	5% (E24) $1Ω ≤ R ≤ 10MΩ$ $0.5%$ , $1%$ (E24/E96) $1Ω ≤ R ≤ 10MΩ$ Jumper < $50mΩ$	$\begin{split} &  \Omega \leq R <  0\Omega \\ & \pm 200 \text{ ppm/}^{\circ}\text{C} \\ &  0\Omega \leq R \leq  0\text{M}\Omega \\ & \pm  00 \text{ ppm/}^{\circ}\text{C} \\ &  00\Omega \leq R \leq  0\text{M}\Omega \\ & \pm 50 \text{ ppm/}^{\circ}\text{C} \end{split}$	Rated Current 2A Max, Current 10A
	1.25W	200V	500V	500V	$5\%$ (E24) $1\Omega \le R \le 10M\Omega$ 0.5%, 1% (E24/E96) $1\Omega \le R \le 10M\Omega$	$I\Omega \le R < I0\Omega$ $\pm 200 \text{ ppm/}^{\circ}\text{C}$ $I0\Omega \le R \le I0M\Omega$ $\pm I00 \text{ ppm/}^{\circ}\text{C}$		
AF2512	ΙW	-	200V	500V	500V	$5\%$ (E24) $1\Omega \le R \le 10M\Omega$ 0.5%, 1% (E24/E96) $1\Omega \le R \le 10M\Omega$ Jumper < $50m\Omega$	$\begin{split} &  \Omega \leq R <  0\Omega \\ & \pm 200 \text{ ppm/}^{\circ}\text{C} \\ &  0\Omega \leq R \leq  0M\Omega \\ & \pm  00 \text{ ppm/}^{\circ}\text{C} \\ &  00\Omega \leq R \leq  0M\Omega \\ & \pm 50 \text{ ppm/}^{\circ}\text{C} \end{split}$	Rated Current 2A Max, Current 10A
	2 W	-	200V	500V	500V	$\begin{array}{c} 5\% \text{ (E24)} \\ 1\Omega \leq R \leq 10 \text{M}\Omega \\ 0.5\%, 1\% \text{ (E24/E96)} \\ 1\Omega \leq R \leq 10 \text{M}\Omega \end{array}$	$I\Omega \le R < I0\Omega$ $\pm 200 \text{ ppm/}^{\circ}\text{C}$ $I0\Omega \le R \le I0M\Omega$ $\pm 100 \text{ ppm/}^{\circ}\text{C}$	

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### FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles of AF-series is the same as RC-series. Please see the special data sheet "Chip resistors mounting".

0100 to 2512

### PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	AF0100	AF0201	AF0402	AF0603 AF0805 AF1206	AF1210	AF1218 AF2010 AF2512
Paper taping reel (R)	7" (178 mm)	20,000	10,000/20,000	10,000/20,000	5,000	5,000	
	13" (330 mm)		50,000	50,000	20,000	20,000	
Embossed taping reel (K)	7" (178 mm)			==			4,000

#### NOTE

1. For paper/embossed tape and reel specification/dimensions, please see the special data sheet "Chip resistors packing".

Ω

### **FUNCTIONAL DESCRIPTION**

### **OPERATING TEMPERATURE RANGE**

AF0100 Range: -55°C to + 125°C

AF0201 - AF2512 Range: -55°C to + 155°C

### **POWER RATING**

Each type rated power at 70°C:

AF0100=1/32W (0.03125W)

AF0201=1/20W (0.05W)

AF0402=1/16 W (0.0625W); 1/8W (0.125W)

AF0603=1/10 W (0.1W); 1/5W (0.2W)

AF0805=1/8 W (0.125W); 1/4W (0.25W)

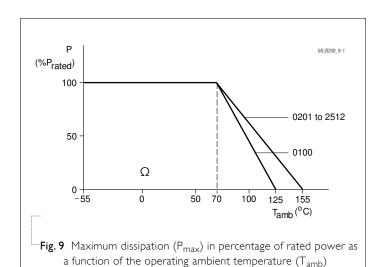
AFI206=1/4 W (0.25W); 1/2W (0.5W)

AFI210=1/2W (0.5W); IW

AF1218=1W; 1.5W

AF2010=3/4W (0.75W); 1.25W

AF2512=1W. 2W



### **RATED VOLTAGE**

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{(P \times R)}$$

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$ 

## TESTS AND REQUIREMENTS

 Table 4
 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature Coefficient of Resistance (T.C.R.)	IEC 60115-1 4.8 MIL-STD-202 Method 304	At +25/-55°C and +25/+125°C  Formula:  T.C.R= $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$	Refer to table 2
		Where $t_1$ =+25°C or specified room temperature $t_2$ =-55°C or +125°C test temperature $R_1$ =resistance at reference temperature in ohms $R_2$ =resistance at test temperature in ohms	
Life/Endurance	IEC 60115-1 4.25 MIL-STD-202 Method 108	At 70±2°C for 1,000 hours, RCWV applied for 1.5 hours on, 0.5 hour off, still-air required	0100: $\pm$ (3.0%+0.05 $\Omega$ ) Others: $\pm$ (1.0%+0.05 $\Omega$ ) <100 m $\Omega$ for Jumper
High Temperature Exposure	MIL-STD-202 Method 108	0100: 1,000 hours at 125°C Others: 1,000 hours at 155±3°C unpowered	0100: $\pm$ (2.0%+0.05 $\Omega$ ) <50 m $\Omega$ for Jumper Others: $\pm$ (1.0%+0.05 $\Omega$ ) <100 m $\Omega$ for Jumper
Moisture Resistance	MIL-STD-202 Method 106	Each temperature / humidity cycle is defined at 8 hours, 3 cycles / 24 hours for IOd. with 25°C / 65°C 95% R.H, without steps 7a & 7b, unpowered Parts mounted on test-boards, without condensation on parts	0100: $\pm (2.0\% + 0.05 \ \Omega)$ <50 m $\Omega$ for Jumper Others: $\pm (0.5\% + 0.05 \ \Omega)$ for 0.5%, 1% tol. $\pm (1.0\% + 0.05 \ \Omega)$ for 5% tol. <100 m $\Omega$ for Jumper
Thermal Shock	MIL-STD-202 Method 107	-55 / +125°C  Number of cycles required is 300.  Devices mounted  Maximum transfer time is 20 seconds.  Dwell time is 15 minutes	0100: $\pm$ (1.0%+0.05 $\Omega$ ) <50 m $\Omega$ for Jumper Others: $\pm$ (0.5%+0.05 $\Omega$ ) for 0.5%, 1% tol. $\pm$ (1%+0.05 $\Omega$ ) for 5% tol. <100 m $\Omega$ for Jumper
Short Time Overload	IEC60115-1 4.13	2.5 times of rated voltage or maximum overload voltage whichever is less for 5 seconds at room temperature	0100: $\pm (2.0\% + 0.05 \ \Omega)$ Others: $\pm (1.0\% + 0.05 \ \Omega)$ <50 m $\Omega$ for Jumper No visible damage
Bending	IEC 60115-1 4.33	Chips mounted on a 90 mm glass epoxy resin PCB (FR4) Bending: 0100/0201/0402: 5 mm 0603/0805: 3 mm 1206 & above: 2 mm Bending time: 60±5 seconds	$\pm (1.0\% + 0.05~\Omega)$ 0100: <50 m $\Omega$ for Jumper Others: <100 m $\Omega$ for Jumper No visible damage

# Chip Resistor Surface Mount AF SERIES 0100 to 2512

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Biased Humidity	MIL-STD-202 method 103	I,000 hours; 85°C /85%R.H., I0% of operating power. Measurement at 24±4 hours after test conclusion.	$0100: \pm (5\% + 0.05\Omega)$ <50 m $\Omega$ for Jumper Others: $I\Omega \le R \le IM\Omega: \pm (3\% + 0.05\Omega)$ $IM\Omega < R \le I0M\Omega: \pm (5\% + 0.05\Omega)$ <100 m $\Omega$ for Jumper
Solderability - Resistance to Soldering Heat	IEC 60115-1 4.18 MIL-STD-202 Method 215	Condition B, no pre-heat of samples Lead-free solder, 260±5°C, 10±1 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	0100: $\pm$ (1.0%+0.05 $\Omega$ ) Others: $\pm$ (0.5%+0.05 $\Omega$ ) for 0.5%, 1% tol. $\pm$ (1.0%+0.05 $\Omega$ ) for 5% tol. <50 m $\Omega$ for Jumper No visible damage
- Wetting	J-STD-002	Electrical test not required  Magnification 10X  SMD conditions:  Others:  (a) Method B, aging 4 hours at 155°C  dry heat, lead-free solder bath at 245°C  (b) Method B, dipping at 215°C for 3 seconds  0100:  Ist step: Method B, aging 4 hours at 155°C dry heat  2nd step: Lead free solder bath at 245°C	Well tinned (≥95% covered) No visible damage
FOS	ASTM-B-809-95* * Modified	Sulfur 750 hours, 105°C. unpowered	0100: $\pm$ (5.0%+0.05Ω) Others: $\pm$ (4.0%+0.05Ω) <100 mΩ for Jumper



# **Chip Resistor Surface Mount** AF SERIES 0100 to 2512

### REVISION HISTORY

DATE	CHANGE NOTIFICATION	DESCRIPTION
Jan. 03, 2023	-	- 10ohm TCR upgrade to 100ppm, for 0603~2512 normal power and 0402~2512 double power.
Mar. 26, 2021	-	- Add TCR 50ppm and size 01005 extend
Nov. 1, 2019	-	- Add in AF double power
Sep. 05, 2019	-	- Updated dimensions
Jun. 21, 2016	-	- Update test and requirement
Dec. 24, 2015	-	- Update Dielectric Withstanding Voltage& Resistance value
Apr. 01, 2015	-	- Modified test and requirements
Nov. 20, 2014	-	- Tests and requirement update
Sep. 27, 2013	-	- Size 0201/1210/1218/2010/2512 extend
Jan 07, 2011	-	- First issue of this specification
	Jan. 03, 2023  Mar. 26, 2021  Nov. 1, 2019  Sep. 05, 2019  Jun. 21, 2016  Dec. 24, 2015  Apr. 01, 2015  Nov. 20, 2014  Sep. 27, 2013	Jan. 03, 2023 -  Mar. 26, 2021 -  Nov. 1, 2019 -  Sep. 05, 2019 -  Jun. 21, 2016 -  Dec. 24, 2015 -  Apr. 01, 2015 -  Nov. 20, 2014 -  Sep. 27, 2013 -

<sup>&</sup>quot;YAGEO reserves all the rights for revising the content of this datasheet without further notification, as long as the products are unchanged. Any product change will be announced by PCN."



### **Chip Resistor Surface Mount**

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